



N-CHANNEL ENHANCEMENT MODE FIELD MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)}	Package	I _D T _A = +25°C	
600V	100Ω @ V _{GS} = 10V	SOT23	80mA	

Description

This new generation uses advanced planar technology MOSFET, provide excellent high voltage and fast switching, making it ideal for small-signal and level shift applications.

Applications

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions



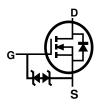


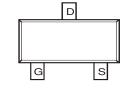
Features

- Low Input Capacitance
- High BV_{DSS} Rating for Power Application
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)





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Top View

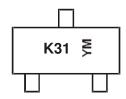
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN60H080DS-7	SOT23	3000/Tape & Reel
DMN60H080DS-13	SOT23	10000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



K31 = Product Type Marking Code YM or \overline{Y} M= Date Code Marking Y or \overline{Y} = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Year	2017		2018	2019)	2020	2021		2022	2023	}	2024
Code	Е		F	G		Н	- 1		J	K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	600	V		
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	70 56	mA
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	80 70	mA
Continuous Drain Current (Note 5) V _{GS} = 4.5V	I _D	40 32	mA		
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	50 40	mA
Pulsed Drain Current @ T _{SP} = +25°C (Note 7)	I _{DM}	0.2	Α		

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation, @T _A = +25°C (Note 5)	P_{D}	0.70	W
Thermal Resistance, Junction to Ambient @ T _A = +25°C (Note 5)	$R_{\theta JA}$	174	°C/W
Power Dissipation, @T _A = +25°C (Note 6)	P_D	1.10	W
Thermal Resistance, Junction to Ambient @ T _A = +25°C (Note 6)	$R_{\theta JA}$	99	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

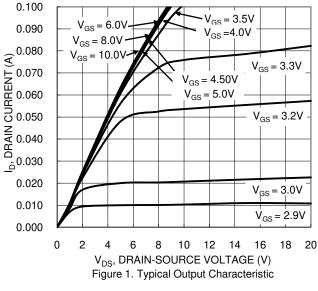
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	600	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1	μΑ	$V_{DS} = 600V, V_{GS} = 0V$		
Gate-Body Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	V	1.5	_	3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$		
Gate Theshold Voltage	V _{GS(TH)}	1.5	_	2.6	V	$V_{DS} = V_{GS}$, $I_D = 8\mu A$		
Static Drain-Source On-Resistance	Б	_	67	100	Ω	$V_{GS} = 10V, I_D = 60mA$		
Static Diani-Source On-Nesistance	R _{DS(ON)}	_	95	290	12	$V_{GS} = 4.5V, I_D = 60mA$		
Forward Transfer Admittance	Y _{fs}	_	76	_	ms	$V_{DS} = 10V, I_D = 60mA$		
Diode Forward Voltage	V_{SD}		_	1.5	V	$V_{GS} = 0V$, $I_S = 50mA$		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	C _{iss}	_	25	_				
Output Capacitance	Coss	_	5.2	_	pF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$		
Reverse Transfer Capacitance	Crss		1.4	_				
Total Gate Charge	Q_g	_	1.7	_		101111 00011		
Gate-Source Charge	Q_{gs}	_	0.3	_	nC	$V_{GS} = 10V, V_{DD} = 300V,$ $I_{D} = 0.01A$		
Gate-Drain Charge	Q_{gd}	_	0.9	_		ID = 0.01A		
Turn-On Delay Time	t _{D(ON)}	_	7	_	ns	V 200V V 40V		
Turn-On Rise Time	t _R	_	10	_	ns	$V_{DD} = 300V, V_{GS} = 10V,$		
Turn-Off Delay Time	t _{D(OFF)}		21		ns	$R_{GEN} = 3.3\Omega$, $I_D = 60 \text{mA}$		
Turn-Off Fall Time	t⊧	_	158	_	ns	TID = OUTIA		
Reverse Recovery Time	t _{RR}	_	189.1	_	ns	V _R =300V, I _F =0.06A,		
Reverse Recovery Charge	Q _{RR}	_	32	_	nC	di/dt = 100A/μs		

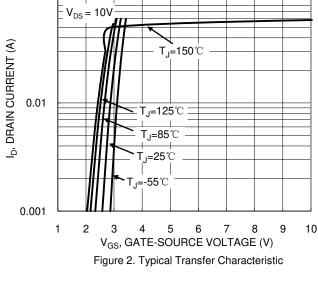
Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
 7. Repetitive rating, pulse width limited by junction temperature, 10µs pulse, duty cycle = 1%.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

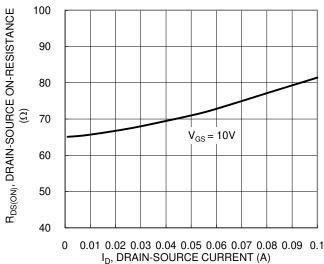








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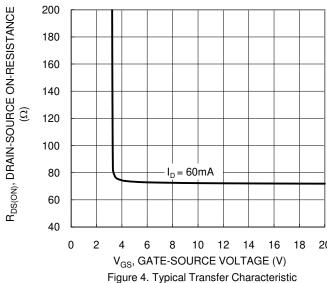
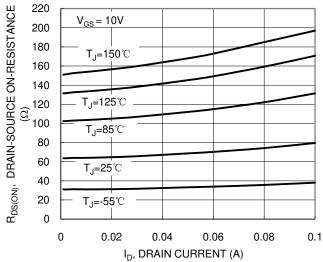


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage



R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE 3 2.5 $V_{GS} = 10V, I_D = 60mA$ (NORMALIZED) 2 1.5 1 $V_{GS} = 4.5V, I_D = 60mA$ 0.5 0 -25 -50 25 50 75 100 125 150 T_{.i}, JUNCTION TEMPERATURE (°C)

Figure 5. Typical On-Resistance vs. Drain Current and Temperature

Figure 6. On-Resistance Variation with Temperature





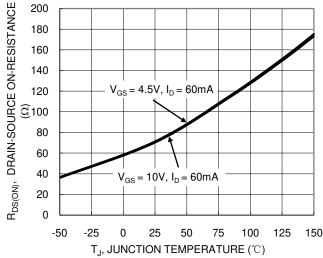


Figure 7. On-Resistance Variation with Temperature

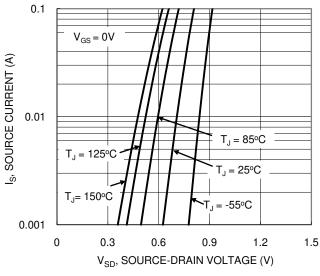


Figure 9. Diode Forward Voltage vs. Current

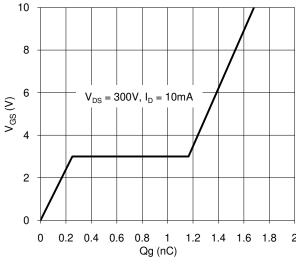
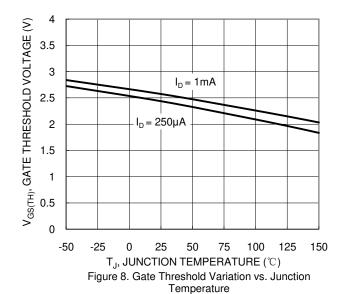
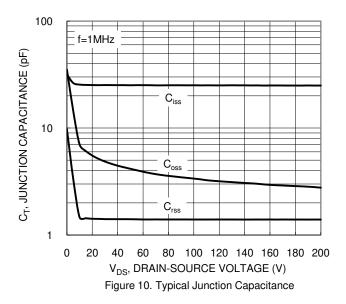
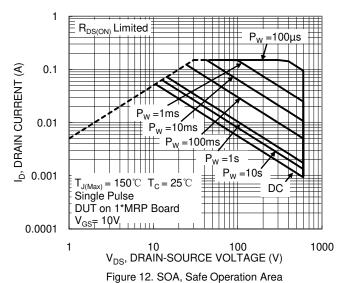


Figure 11. Gate Charge









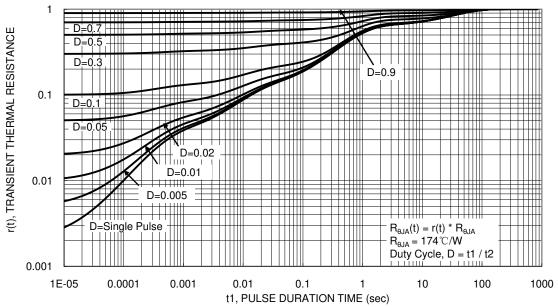


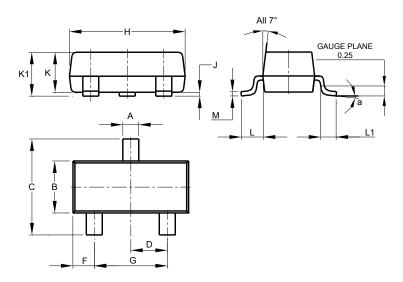
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

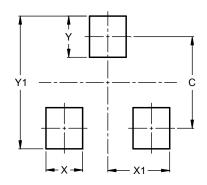


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)				
С	2.0				
Х	0.8				
X1	1.35				
Υ	0.9				
V1	29				



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